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INTERNATIONAL STANDARD

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Reliability growth – Statistical test and estimation methods

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

RELIABILITY GROWTH – STATISTICAL TEST AND ESTIMATION METHODS

FOREWORD

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International Standard IEC 61164 has been prepared by IEC technical committee 56: Dependability.

This second edition cancels and replaces the first edition, published in 1995, and constitutes a technical revision.

The main changes with respect to the previous edition are listed below:

- addition of two statistical models for reliability growth planning and tracking in the product design phase;
- statistical methods for the reliability growth programme in the design phase of IEC 61014;
- addition of the discrete reliability growth model for the test phase;
- addition of the fixed number of faults model for the test phase;
- clarification of the symbols used for various models;
- addition of real life examples for most of the statistical models;
- numerical correction of tables in the reliability growth test example.

This standard should be used in conjunction with IEC 61014.

The text of this standard is based on the following documents:

FDIS	Report on voting
56/920/FDIS	56/939/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until 2011. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

INTRODUCTION

This International Standard describes the power law reliability growth model and related projection model and gives step-by-step directions for their use. There are several reliability growth models available, the power law model being one of the most widely used. This standard provides procedures to estimate some or all of the quantities listed in Clauses 4, 6 and 7 of IEC 61014.

Two types of input are required. The first one is for reliability growth planning through analysis and design improvements in the design phase in terms of the design phase duration, initial reliability, reliability goal, and planned design improvements, along with their expected magnitude. The second input, for reliability growth in the project validation phase, is for a data set of accumulated test times at which relevant failures occurred, or were observed, for a single system, and the time of termination of the test, if different from the time of the final failure. It is assumed that the collection of data as input for the model begins after the completion of any preliminary tests, such as environmental stress screening, intended to stabilize the product's initial failure intensity.

Model parameters estimated from previous test results may be used to plan and predict the course of future reliability growth programmes, provided the conditions are similar.

Some of the procedures may require computer programs, but these are not unduly complex. This standard presents algorithms for which computer programs should be easy to construct.

RELIABILITY GROWTH – STATISTICAL TEST AND ESTIMATION METHODS

1 Scope

This International Standard gives models and numerical methods for reliability growth assessments based on failure data, which were generated in a reliability improvement programme. These procedures deal with growth, estimation, confidence intervals for product reliability and goodness-of-fit tests.

2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60050(191):1990, *International Electrotechnical Vocabulary (IEV) – Chapter 191: Dependability and quality of service*

IEC 60300-3-5:2001, *Dependability management – Part 3-5: Application guide – Reliability test conditions and statistical test principles*

IEC 60605-4, *Equipment reliability testing – Part 4: Statistical procedures for exponential distribution – Point estimates, confidence intervals, prediction intervals and tolerance intervals*

IEC 60605-6, *Equipment reliability testing – Part 6: Tests for the validity of the constant failure rate or constant failure intensity assumptions*

IEC 61014:2003, *Programmes for reliability growth*